

Electronic Acknowledgement Receipt

EFS ID:	6919450
Application Number:	10715641
International Application Number:	
Confirmation Number:	4323
Title of Invention:	RAISED SOLDER-MASK-DEFINED (SMD) SOLDER BALL PADS FOR A LAMINATE ELECTRONIC CIRCUIT BOARD
First Named Inventor/Applicant Name:	Tz-Cheng Chiu
Customer Number:	23494
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Application Type:	Utility under 35 USC 111(a)

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Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Request for Certificate of Correction	TI-36052_CERTIFICATE_OF_CO RRECTION_TRANSMITTAL.pdf	44850	no	1
			4380277c4072556ca030ea185a2423ef177834a		
Warnings:					
Information:					
2	Request for Certificate of Correction	TI-36052_CERTIFICATE_OF_CO RRECTION.pdf	210679	no	2
			a3601c6e7dc79f5ce887e7c4e69917501cbea6		
Warnings:					
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3	Drawings-only black and white line drawings	TI-36052_CORRECTED_DWG_S HT04.pdf	30824	no	1
			280d794c22a0b4d79638d55c88f59bee97e41a		
Warnings:					
Information:					
4	Fee Worksheet (PTO-875)	fee-info.pdf	30306	no	2
			3383d0e88a23ae529a308d1127d380aed09ee5c		
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